



DATE: October 28, 2016  
 TO: OCB-AM Sales Team  
 FROM: Omron Electronic Components, Product Marketing

### G6C PCB Power Relay – Relay Case Appearance Change

In an effort to enhance our production process, Omron will change the G6C relay manufacturing mold effective as of our production in May 2017. This modification notice will explain the appearance changes of the G6C relay case as the new manufacturing mold will have a different gate position. The manufacturing mold change will not alter the technical specifications or external dimensions of the relay. The models to be affected include, but are not limited to the models listed below; should you have any additional questions, however, please communicate with the Relay Product Specialist.

**Effective Date:**

Effective as of our production in May 2017

**G6C Appearance Shape Change:**

Mold Gate Position before the change		Mold Gate Position after the change	
Current position of the mold gate is on the side of the relay		New position of the mold gate will be on the top of the relay	
(Side View)	(Top View)	(Side View)	(Top View)
Current appearance shape of relay does not have "step" shape		New appearance shape of relay <u>will</u> have "step" shape	
(Side View)	(Top View)	(Side View)	(Top View)